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Epitaxial growth of large-area single-layer graphene over Cu(111)/sapphire by atmospheric pressure CVD

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We report the atmospheric pressure chemical vapor deposition (CVD) growth of single-layer graphene over a crystalline Cu(111) film heteroepitaxially deposited on c-plane sapphire. Orientation-controlled, epitaxial single-layer graphene is achieved over the Cu(111) film on sapphire, while a polycrystalline Cu film deposited on a Si wafer gives non-uniform graphene with multi-layer flakes. Moreover, the CVD temperature is found to affect the quality and orientation of graphene grown on the Cu/sapphire substrates. The CVD growth at 1000 °C gives high-quality epitaxial single-layer graphene whose orientation of hexagonal lattice matches with the Cu(111) lattice which is determined by the sapphire's crystallographic direction. At lower CVD temperature of 900 °C, low-quality graphene with enhanced Raman D band is obtained, and it showed two different orientations of the hexagonal lattice; one matches with the Cu lattice and another rotated by 30°. Carbon isotope-labeling experiment indicates rapid exchange of the surface-adsorbed and gas-supplied carbon atoms at the higher temperature, resulting in the highly crystallized graphene with energetically most stable orientation consistent with the underlying Cu(111) lattice.

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1. Introduction

Graphene is a two dimensional crystalline sheet of carbon atoms arranged in a honeycomb lattice that shows various fascinating physical properties, such as quantum Hall effect at room temperature, a tunable band gap, extremely high mobility, and high elasticity [1-4]. These properties promise applications in future electronics, such as transistors, transparent electrodes, liquid crystal devices, and supercapacitors [5-8]. Therefore, preparation of high-quality graphene sheets with low cost as well as integration with other materials has been attracting much attention. Since the graphene prepared by mechanical exfoliation of bulk graphite is limited in the uniformities of size, structure, and film thickness, several other approaches have been developed to synthesize graphene [10]. High temperature annealing of single crystalline SiC(0001) leads to the formation of epitaxial graphene, but the SiC substrates are expensive and it is difficult to transfer the epitaxial graphene onto other substrates [10-11]. Self-assembly of solution-based exfoliated graphite and graphite oxide could achieve continuous and low-cost graphene films [6,12,13], but it suffers from many structural defects and, thus, one cannot expect the intrinsic transport properties of graphene film [14].

Chemical vapor deposition (CVD) over transition metals have attracted a great interest as an effective and powerful means to prepare easily-transferrable, high quality graphene films. Most of the CVD growth uses polycrystalline Ni [15-20], Fe [21], and Cu [22-26] films/foils, and it has been considered that Ni and Fe gives inhomogeneous graphene films with multi-layer flaks, while Cu gives single-layer graphene due to low carbon solubility [22,27]. Although control of the orientation of hexagonal lattice of graphene is essential for studying the transport property and for graphene engineering, most CVD research works obtain graphene with random orientation of hexagonal lattice of graphene (i.e. different orientation in each graphene domain [28]) due to polycrystallinity of catalytic metal films/foils. Single crystalline metal substrates, such as Ni(111), Ru(0001), and Ir(111), enables the orientation-controlled growth, because graphene forms commensurate structure with these metal surfaces [29-33]. However, these substrates are limited in size and very expensive so that they are not suitable for practical applications. In addition, ultra-high vacuum chamber

is used to grow single-layer graphene for these crystalline substrates, again, limiting the size and scalability of the graphene synthesis.

More promising and practical approach is to use metal films heteroepitaxially deposited on conventional single crystalline substrates. We demonstrated that the heteroepitaxial Co films on MgO(100) and MgO(111) substrates can be used to graphene growth, but rectangular and triangular pits which appeared on the Co surface stimulated the graphene growth inside them [34]. Very recently, this approach has been further developed to make uniform single-layer graphene over heteroepitaxial Co, Ni, and Ru films [35-37]. It was demonstrated that even Co and Ni, which have relatively high carbon solubility, can catalyze the growth of uniform single-layer graphene when the crystallinity is high enough [35,36]. However, the graphene films transferred from these crystallized Co and Ni films showed a relatively strong Raman D band at $\sim 1350\text{ cm}^{-1}$, signifying the presence of significant amount of defects [35,36]. We speculate that this is accounted for by strong interaction between these catalyst metals and graphene [35]. Calculations based on density functional theory indicates that Co and Ni have much higher binding energies (0.160 and 0.125 eV, respectively) with graphene than Cu (0.033 eV) [38]. The experimental analysis for the graphene grown on a single crystalline Ni(111) suggests significant hybridization between Ni and C atomic orbitals based on the observed short graphene-Ni distance [29]. Therefore, the chemical etching used for the graphene transfer would give rise to the formation of dangling bonds. Because the chemical etching is done in aqueous solution, these dangling bonds are likely to form sp^3 -carbon atoms that can be terminated with, for example, hydrogen or hydroxyl, carboxylic groups. The presence of these sp^3 -carbon atoms makes graphene domain smaller with many edges that could induce the strong Raman D band. The graphene formed on heteroepitaxial Ru film also showed strong D band after the transfer, which suggests difficulty in etching the chemically inert Ru metal without avoiding the damage to graphene [37].

Here, we report atmospheric pressure CVD growth of large area graphene on crystalline Cu(111) film which is heteroepitaxially deposited on c-plane sapphire ($\alpha\text{-Al}_2\text{O}_3$). The graphene transferred from the Cu(111) shows negligible D band, signifying higher quality

than that transferred from the Co/sapphire substrate. Moreover, the orientation of hexagonal lattice of graphene matches with the underneath Cu(111) lattice. We also show temperature-dependent graphene growth based on carbon isotope labeling experiments.

2. Experimental

2.1. Synthesis and transfer of graphene film

Cu films (500 nm thickness) were deposited onto c-plane α -Al₂O₃ and SiO₂ (300 nm)/Si substrates with a power of 300 W in Ar atmosphere (0.6 Pa) by a radio frequency (RF) magnetron sputtering machine (Shibaura Mechatronics Corp., CFS-4ES). For CVD, as-sputtered Cu film was placed on a quartz sample holder with magnetic handle for the purpose of rapid cooling, and then inserted into a horizontal quartz tube. The substrate was heated up in the quartz tube and annealed for 60 min under ambient pressure with a gas flow of H₂/Ar (volume concentrations of H₂ are ~ 2% at both 900 °C and 1000 °C), followed by introducing CH₄ gas for 10 min (the volume ratios of CH₄/H₂/Ar are 4/2/94 at 900 °C, and 0.4/2/97.6 at 1000 °C, respectively). Finally, the sample was rapidly cooled down to room temperature by moving the sample holder to outside the furnace with a magnet under the H₂/Ar flow.

The transfer process is similar to the previous report [34]. In brief, after the CVD, the substrate surface was covered with PMMA by spin-coating. Thermal tape (Revalpha, Nitto Denko) was attached onto the PMMA film. Then, the Cu film was dissolved in FeCl₃/HCl aqueous solution to release the graphene supported with PMMA and thermal tape. Subsequently, the thermal tape/PMMA/graphene was washed with deionized water and transferred onto a target SiO₂/Si substrate, and then baked at 120 °C for 30 min. Finally, the thermal tape and PMMA were removed together by acetone, leaving the graphene film on the SiO₂/Si substrate.

2.2. Characterization

Raman spectra and mapping images of graphene films were measured with JASCO NRS-2100 using 514.5 nm excitation wavelength. Transmission electron microscope (TEM)

images of samples which were sliced with a focused ion beam (FIB, HITACHI NB 5000) were measured with a HITACHI H-9500 at 300 keV acceleration voltage. Atomic force microscope (AFM) images were measured with a Bruker, Nanoscope IIIa. The crystallinity and crystallographic orientation of Cu films were measured by an X-ray diffraction (XRD) (RIGAKU RINT 2500) and synchrotron XRD at SAGA Light Source (beamline BL15). The crystal phase was identified by a scanning electron microscope (SEM, Zeiss Ultra55) equipped with an electron backscatter diffraction (EBSD, TSL Solutions OIM). Low energy electron diffraction (LEED) patterns of as-grown graphene were recorded in an ultra high vacuum chamber with a pressure of $<8 \times 10^{-9}$ Pa equipped with a LEED optics (OMICRON SPECTALEED).

3. Results and discussion

3.1. Crystallographic characterizations of Cu films

First, we examined the crystallinity of a Cu film, because a Cu film plays an essential role in catalytic growth of graphene. After CVD growth, XRD measurements were performed for the Cu films deposited on sapphire c-plane and SiO₂(300 nm)/Si substrates. As shown in Fig. 1a and Supplementary Material (Fig. S-1a), the Cu films on sapphire showed clear diffraction peaks solely from Cu(111) ($2\theta=43.4^\circ$), while the Cu/SiO₂/Si sample gave two peaks from Cu(111) and Cu(200) ($2\theta=50.6^\circ$). Since the as-grown graphene was very thin, no diffraction peak from graphene was detected. The present XRD data indicate that the crystalline Cu phase is realized on c-plane sapphire with the crystallographic Cu(111) orientation parallel to Al₂O₃(0001), while the Cu on SiO₂/Si is polycrystalline.

To confirm epitaxial relationship of Cu(111) with the sapphire, we chose Cu 200 as Bragg position and performed a ϕ scan by rotating the sample normal to the surface with synchrotron XRD. As shown in Figs. 1b and S-1b, the diffraction peaks appear periodically at intervals of 60° and have quite narrow full width at half maximum (FWHM), proving that Cu films were epitaxially grown on the sapphire substrates. Since a single [111] pole has a three-fold trigonal symmetry, it is highly likely that the observed six-fold symmetry results from two sets of Cu(111) crystallites with azimuthal orientation 60° apart [39]. We also

measured the Bragg diffractions of sapphire 0224 to investigate the crystallographic relationship between Cu film and c-plane sapphire and obtained the epitaxial relationship, expressed as $\text{Cu}(111)[\bar{2}\bar{1}\bar{1}] // \text{Al}_2\text{O}_3(0001)[\bar{2}\bar{1}\bar{1}0]$, consistent with previous literature [39,40]. On the contrary, the Cu film deposited on the SiO_2/Si substrate showed no epitaxial geometry (see Fig. 1c).

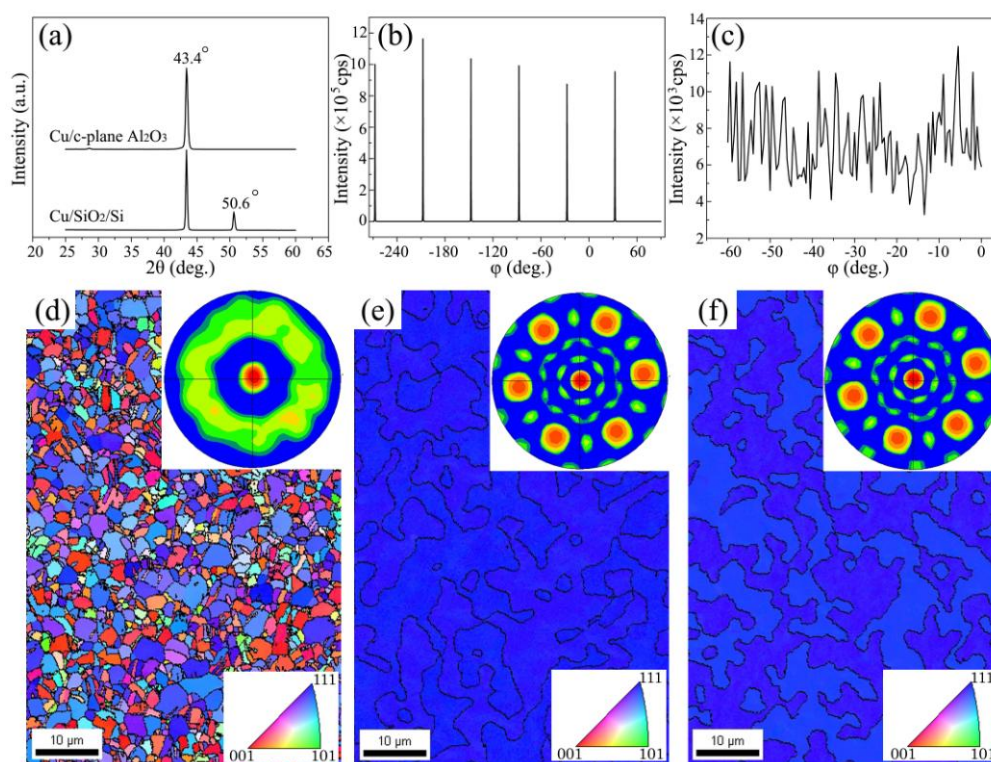


Fig. 1 Crystallographic characterizations of Cu films deposited on c-plane sapphire and SiO_2/Si substrates measured after CVD. (a) θ - 2θ profiles of XRD of these Cu films. ϕ scan profiles of XRD of Cu/sapphire (b) and Cu/ SiO_2/Si (c). The samples were measured after 900 °C CVD. Crystal orientation distributions and [111] pole figures (inset) of Cu/ SiO_2/Si after 900 °C CVD (d), Cu/sapphire after 900 °C CVD (e), and Cu/sapphire after 1000 °C CVD (f).

To identify the crystal texture of Cu films, we performed EBSD measurement (Fig. 1d-f). As seen in Fig. 1d, the Cu film on the SiO_2/Si substrate shows a number of small grains with different crystallographic orientations, and the corresponding [111] pole figure (inset) shows a ring pattern. The data indicates the polycrystalline nature of the Cu film due to underneath

amorphous SiO₂ surface layer. The Cu films on sapphire (Fig. 1e,f) exhibit similar shades with blue color, corresponding to the same crystalline Cu(111) with no significant difference for 900 and 1000 °C CVD samples. One can see boundaries between two kinds of Cu(111) grains, revealing the different crystallographic orientations of the Cu(111) grains. This represents twin structure of the Cu films. The [111] pole figures (Fig. 1e,f insets) showed the six-fold symmetrical patterns at intervals of 60°, indicating that the two kinds of Cu(111) grains are rotated by 60°. These six-fold symmetrical patterns are consistent with the above X-ray ϕ scan profiles. The Cu grain size can be estimated to ~10 μm which is much larger than that of the Cu on SiO₂/Si substrate (1~2 μm).

3.2. Atmospheric pressure CVD growth

Although the vacuum CVD process has been widely used for Cu catalysts [22-24], atmospheric pressure CVD growth of high-quality single-layer is demanded, because the atmospheric CVD is applicable to large-scale graphene growth with low cost [25,26]. In addition, the thermal evaporation of Cu, which contaminates the CVD chamber, is significantly reduced by increasing the growth pressure. Our atmospheric pressure CVD was performed using the optimized CH₄/H₂/Ar flow for 10 min at 900 °C or 1000 °C. The graphene films were routinely transferred onto a target SiO₂/Si substrate by using PMMA and etching solution for reliable characterizations. Figure 2 compares effects of substrates and CVD temperature on the Cu surface and the transferred graphene film. One can see that the Cu on c-plane sapphire exhibits much smoother surfaces than the Cu/SiO₂/Si. This suggests that the Cu film deposited on sapphire is more stable than that on SiO₂/Si due to the higher crystallinity of Cu metal as seen in Fig. 1d-f. The optical microscope images taken after the transfer also show clear difference between the graphene films grown on Cu/sapphire and Cu/SiO₂/Si; the former appear homogeneous, but the latter contains a large fraction of multi-layer graphene flakes which looks darker in the micrograph. These results suggest that graphene nucleation preferentially takes place at the grain boundaries of Cu film and that the graphene growth cannot be simply explained by the surface self-limiting mechanism [23] at least for our atmospheric pressure CVD. The result indicates that the crystalline Cu(111)

film is favorable for the growth of uniform graphene rather than the polycrystalline one. We note that the graphene grown at 900 °C over Cu/sapphire contains few-layer graphene areas (Fig. 2e), while the graphene grown at 1000 °C is more uniform without clear contrast (Fig. 2f).

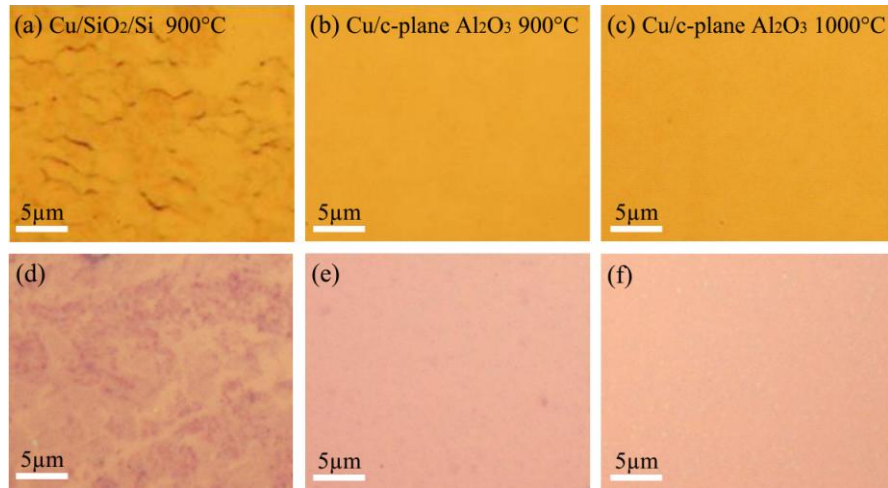


Fig. 2 Optical micrographs of the surfaces of Cu/SiO₂/Si (a) and Cu/sapphire (b) after the CVD at 900 °C, and that of Cu/sapphire after the CVD at 1000 °C (c). (d-f) optical micrographs of graphene films transferred from (a-c), respectively.

Figure 3a-c displays surface morphologies of the as-sputtered Cu film on sapphire and that after CVD, measured by AFM. The as-sputtered Cu film shows very rough surface together with a number of Cu particles, but the CVD process was found to smoothen the surface although micrometer-scale roughness newly appeared. This surface smoothing is more clearly seen for 1000 °C CVD sample. The formation of graphene layer at high temperature as well as H₂ reduction is considered to contribute to flatten the Cu surface, as was claimed by Mun et al. [41]. Figure 3d shows a cross-sectional TEM image for the as-grown graphene on Cu, where single-layer graphene is observed.

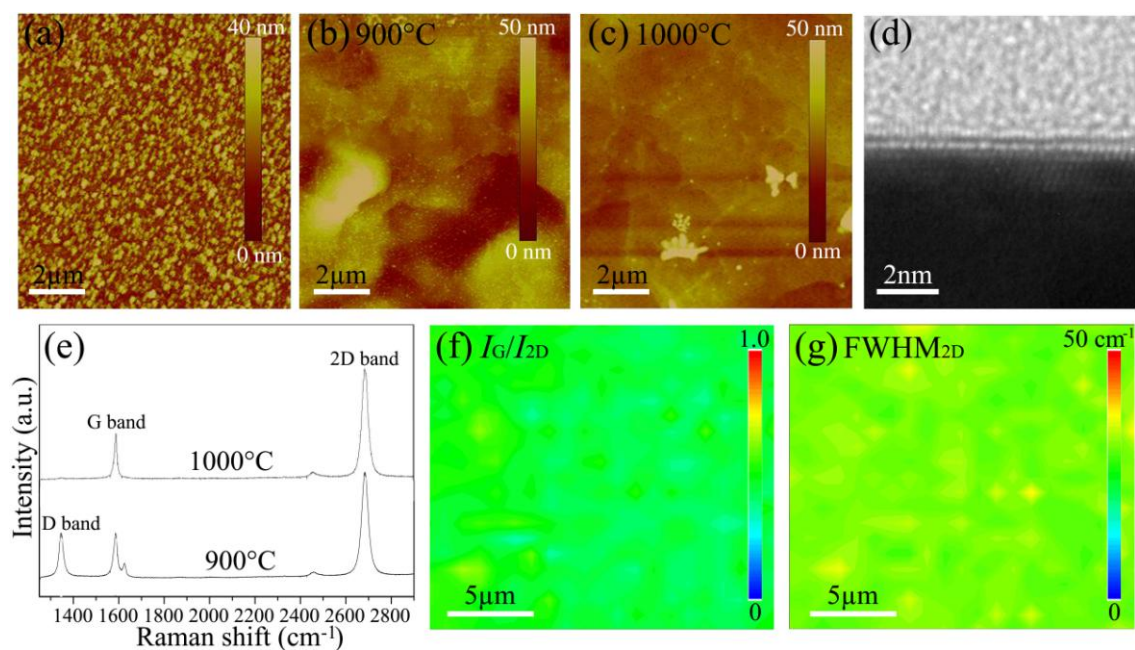


Fig. 3 AFM images of surfaces of as-sputtered Cu film on sapphire (a), and graphene/Cu/sapphire samples grown at 900 °C (b) and 1000 °C (c). (d) Cross-sectional TEM image of as-grown graphene/Cu/sapphire sample at 900 °C CVD. (e) Representative Raman spectra of transferred graphene films grown at 900 and 1000 °C. Raman mapping images of I_G/I_{2D} ratio (f) and FWHM_{2D} (g) of the transferred graphene grown at 1000 °C.

Thickness and uniformity of transferred graphene films were assessed by Raman spectroscopy. As seen in Fig. 3e, the Raman spectra of the graphene films show a low I_G/I_{2D} ratio of ~ 0.4 for both 900 and 1000 °C-grown samples. The 2D band located at $\sim 2685 \text{ cm}^{-1}$ has narrow linewidth (FWHM_{2D}) ($30\text{-}40 \text{ cm}^{-1}$) which can be fitted by single Lorentzian. These results confirm the growth of single-layer graphene [16,22,42]. However, the graphene grown at 900 °C showed the strong D band at 1350 cm^{-1} together with D' band at 1620 cm^{-1} , indicating the presence of significant defects and/or domain boundaries in $\sim 1 \mu\text{m}$ laser spot used for the Raman measurement [24]. Raman mappings images of G and 2D band intensities of 900 °C-CVD sample show that some areas have high I_G/I_{2D} ratios of ~ 1.0 , indicating the presence of few-layer graphene domains as well as single-layer graphene (Fig. S-2). On the other hand, the graphene grown at 1000 °C showed negligible or very weak D band with I_D/I_G ratio of <0.05 , denoting high quality of graphene even after the transfer

process. For more wide area inspection, we measured the Raman mapping for $20\ \mu\text{m}\times 20\ \mu\text{m}$ area, as shown in Fig. 3f,g. The I_G/I_{2D} ratio and FWHM_{2D} are ~ 0.40 and $30\text{-}40\ \text{cm}^{-1}$, respectively, for the scanned area, confirming the uniformity of our CVD graphene. The slight variation of I_G/I_{2D} might be attributed to spatially nonuniform adhesion between the graphene film and SiO_2/Si substrate during the transfer process [43]. Therefore, increasing the growth temperature is an effective way to improve the quality of single-layer graphene by suppressing the defect-induced D band and multi-layer graphene formation. The crystallinity of a Cu film is also important for uniform single-layer graphene growth.

3.3. Orientation of graphene films

To study the orientation of hexagonal lattice of graphene, we measured LEED for the graphene on the Cu(111) film with an electron beam energy of 50-300 eV. Figure 4 compares the LEED patterns of the as-grown graphene films grown at 900 and 1000 °C measured with electron energy of 140 eV (for different energies, see Fig. S-3). Since the spot size of electron beam is around 1 mm, a LEED pattern shows the average orientation of a graphene film. It should be noted that the as-sputtered Cu film did not show any diffraction patterns because the Cu surface is easily oxidized during transfer from a sputtering chamber to a LEED chamber. The oxidation disturbs the Cu surface, and the periodicity of Cu(111) surface is lost upon oxidation. However, when graphene covers the Cu surface, we could observe the clear diffraction patterns, as shown in Figs. 4 and S-3. This indicates that a graphene film prevents the Cu from surface oxidation, giving the diffractions from both graphene and Cu(111) surface.

In the case of 900 °C CVD, bright spots are located at the hexagonal vertexes which correspond to fcc(111) structure of Cu film. This is consistent with the above synchrotron XRD and EBSD measurements. Our I - V measurements indicate that weak diffraction spots observed at the present energy are originated in graphene [35]. In addition, the close look at the bright spots indicate that they contain both the diffractions from Cu(111) and graphene with the Cu diffraction spots locating slightly closer to the center. This originates from the difference in lattice constants of graphene and Cu(111) (lattice constants of graphene and

Cu(111) are 2.46 Å and 2.56 Å, respectively). The observed LEED pattern indicates that there are two sets of graphene orientations; one with the same orientation with the underneath Cu(111) lattice and another with 30°-rotation (see Fig. 4c). We, thus, speculate that the as-grown graphene film consists of two rotational domains. The presence of rotational domains may bring a significant amount of domain boundaries which are supposed to give the observed D band (Fig. 3e).

When the graphene was grown at 1000 °C, the diffraction from the 30°-rotated graphene domain disappeared (Fig. 4b), denoting complete match of single-layer graphene to the underlying Cu(111). In addition, clear satellites assigned to moiré structure were observed. The moiré pattern results from the small lattice mismatch between graphene and Cu(111) surface [44], and it also indicates sufficiently large graphene domain size. Further analysis of the moiré pattern, shown in Fig. S-4, suggests (8×8) structure assuming the thermal expansion difference of 7%. At 900 °C, however, the moiré pattern was not observed probably due to the coexistence of two rotated graphene domains and small domain size of graphene grown at 900 °C. The origin of the observed temperature-dependent graphene orientations will be discussed later.

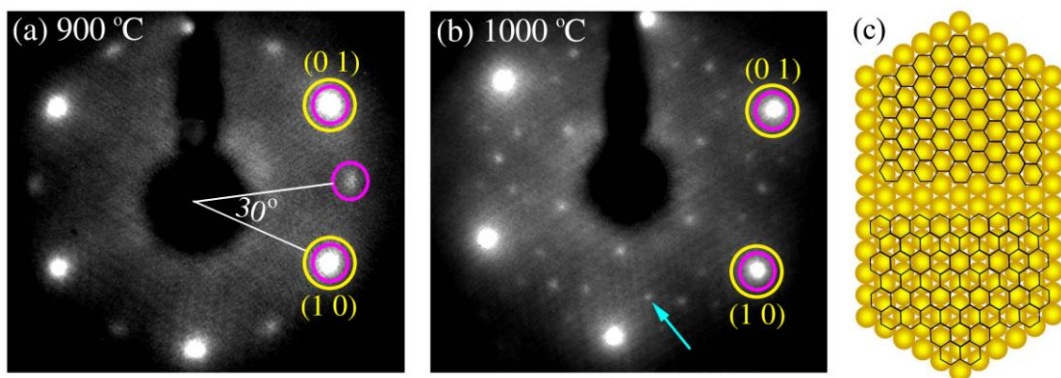


Fig. 4 LEED patterns of as-grown graphene/Cu/sapphire samples grown at 900 °C (a) and 1000 °C (b). The beam energy is 140 eV. The pink and yellow circles indicate the diffraction spots of graphene and Cu(111), respectively. The arrow in (b) indicates moiré pattern. (c) Illustration of atomic configuration of graphene films on Cu (111) with crystallographic orientation rotated by angles of 0° (upper) and 30° (below). The graphene film grown at 900 °C has both orientations, while the film grown at 1000 °C has only 0° rotation.

3.4. Carbon isotope-labeled CVD

To investigate the growth mechanism of graphene under atmospheric pressure CVD, we performed carbon isotope labeled CVD to track the carbon atoms during the graphene growth process for the different growth temperatures. We introduced $^{13}\text{CH}_4$ in the first 0-3 min and $^{12}\text{CH}_4$ in the successive 3-10 min into reaction chamber during CVD. Figure 5 shows the Raman data of transferred graphene grown at 900 °C. The Raman spectra showed two separated G bands as well as two separated 2D bands (Fig. 5c,f). The G and 2D bands at $\sim 1520\text{ cm}^{-1}$ and $\sim 2585\text{ cm}^{-1}$, respectively, correspond to the pure ^{13}C -graphene, while the peaks at $\sim 1570\text{ cm}^{-1}$ and $\sim 2660\text{ cm}^{-1}$ indicate the formation of isotopically-mixed graphene. The actual composition of the carbon isotopes is estimated to be ^{12}C -77% and ^{13}C -23% based on the following equation [45]:

$$\omega = \omega_{12} [m_{12}/(n_{12}m_{12}+n_{13}m_{13})]^{1/2} \quad (1)$$

where, ω_{12} is the Raman mode frequency of pure ^{12}C -graphene, n_{12} and n_{13} are the atomic fractions of ^{12}C and ^{13}C , and m_{12} and m_{13} are the atomic masses of ^{12}C and ^{13}C , respectively. It is noted that Raman spectra of the graphene films do not show any bands of pure ^{12}C -graphene domains. Thus, it is likely that the initially introduced ^{13}C atoms form pure ^{13}C -graphene domains before introducing $^{12}\text{CH}_4$. In addition, we found that the I_G/I_{2D} ratio is generally higher for the pure ^{13}C -graphene than the isotopically mixed graphene (e.g. measured point A in Fig. 5). This suggests that the ^{13}C -graphene partly contains few layer domains. Therefore, we speculate that initially introduced ^{13}C atoms segregate from grain boundaries remaining on the Cu surface during heating at 900 °C. This is supported by the fact that graphene is strongly dependent on the CVD time for 900 °C, which indicates that Cu surface has more grain boundaries during the initial growth period (see Fig. S-5). On the other hand, the ^{13}C - ^{12}C mixed graphene is uniform and mainly single-layer. We infer that the ^{13}C and ^{12}C atoms exchange at the Cu surface which involves many dynamic processes, such as catalytic CH_4 decomposition, surface carbon diffusion, dissolution of carbon atoms into the Cu film, removal of surface carbon atoms by hydrogen, healing the Cu surface, and segregation of graphene. It is noted that the present graphene growth mechanism is

different from the surface adsorption mechanism proposed for the vacuum CVD on polycrystalline Cu where the ^{12}C and ^{13}C atoms are not mixed at all [45].

When the growth temperature was increased to 1000 °C, whole graphene showed the isotopically mixed G and 2D bands, as displayed in Fig. 6. In addition, the composition is quite uniform as seen in the mapping images. These data represent that the exchange of ^{13}C and ^{12}C atoms occurred more frequently than at 900 °C CVD. As shown in Fig. S-6, performing CVD for 3 min still gave uniform, single-layer graphene, indicating the Cu surface is fully covered with graphene in the first 3 min. Also differently from the case at 900 °C, independence of graphene growth on the CVD time at 1000 °C reveals relatively fewer grain boundaries at the initial growth stage. This may be another reason why the initially introduced ^{13}C atoms did not form the pure ^{13}C -graphene domains. We further investigated the Raman result of the different $^{13}\text{CH}_4$ - $^{12}\text{CH}_4$ supply timing shown in Figs. S-7,8 (8 min $^{13}\text{CH}_4$, followed by 2 min $^{12}\text{CH}_4$); the longer $^{13}\text{CH}_4$ supply time still resulted in the isotopically mixed graphene without forming pure ^{13}C -graphene. Therefore, it is suggested that the graphitization occurs during the rapid cooling, considering the complete mixing of ^{13}C - ^{12}C isotopes.

To further study the growth mechanism of single-layer graphene on Cu(111), we supplied CH_4 for short times, 10 sec, 30 sec, and 60 sec. The result is summarized in Fig. S-9. The number of graphene domains increased with increasing CH_4 supply time, while the domain size did not significantly increase with the supply time. The present result suggests the different growth model proposed for vacuum CVD, in which graphene's domains size gradually increases with the CVD time [45]. Therefore, we speculate that the graphene nucleation (or graphitization) occurs during the cooling process in which the total area of the segregated graphene is correlated to the total amount of supplied CH_4 . In this model, the catalytically decomposed carbon atoms stay on the Cu surface during CVD but not completely graphitized. Similar to other CVD works [15,27], the cooling rate strongly influenced graphene films; slow cooling gave preferential formation of multi-layer graphene flakes (not shown here). This result suggests that the graphene growth on our Cu film is not the simple surface reaction for the atmospheric CVD. We also think that even for

atmospheric CVD the CH_4 concentration supplied during CVD influences the growth dynamics of graphene on the Cu surface. Further study like *in-situ* growth measurement is necessary for better understanding of the growth mechanism. After 60 sec CH_4 supply, more than half of the Cu surface area was covered with the graphene domains. This is consistent with the whole surface coverage observed after 3 min CVD (see Fig. S-6). Thus, the carbon isotope labeling experiments ($^{13}\text{CH}_4$ 0-3 min, $^{12}\text{CH}_4$ 3-8 min) shown in Fig. 6 support the surface exchange reaction of ^{13}C - ^{12}C atoms at 1000 °C. In addition, after 60 sec, hexagonal graphene domains appeared on the Cu surface. Such hexagonal domain structure was reported recently for the atmospheric CVD [46,47].

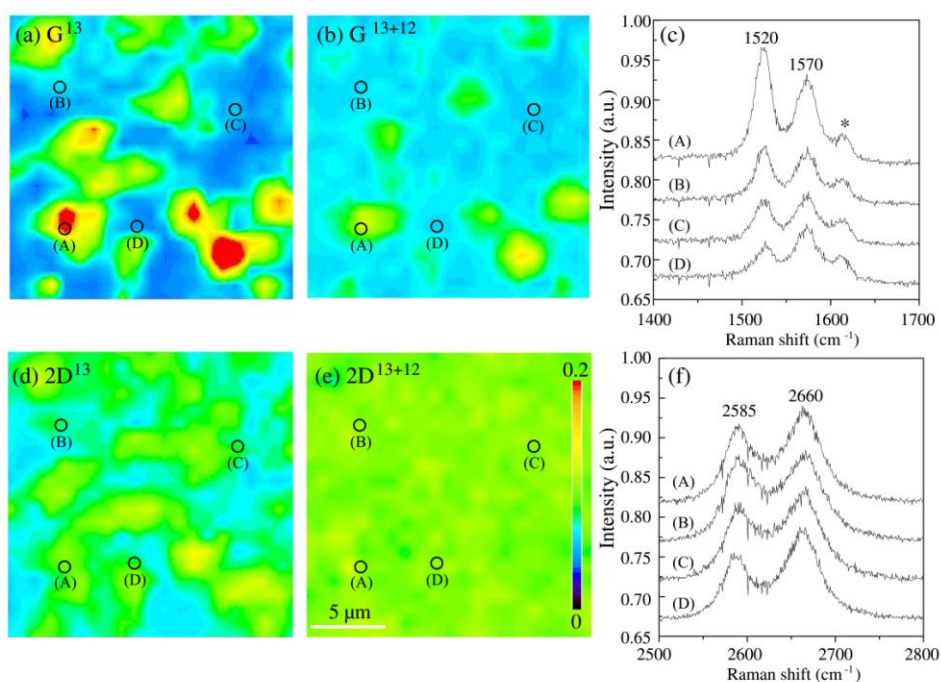


Fig. 5 Raman measurement of transferred graphene with $^{13}\text{CH}_4$ (0-3 min) and $^{12}\text{CH}_4$ (3-10 min) grown from 900 °C CVD. Raman mapping images of G bands at 1520 cm^{-1} (a) and 1570 cm^{-1} (b). (c) Raman spectra of G bands of 4 random points marked with (A), (B), (C), and (D) in the same region as (a) and (b). Raman mapping images of 2D bands at 2585 cm^{-1} (d) and 2660 cm^{-1} (e). (f) Raman spectra of 2D bands of 4 random points in the same region as (d) and (e). The symbol “*” at around 1620 cm^{-1} in (c) indicates the defect-related D’ peak.

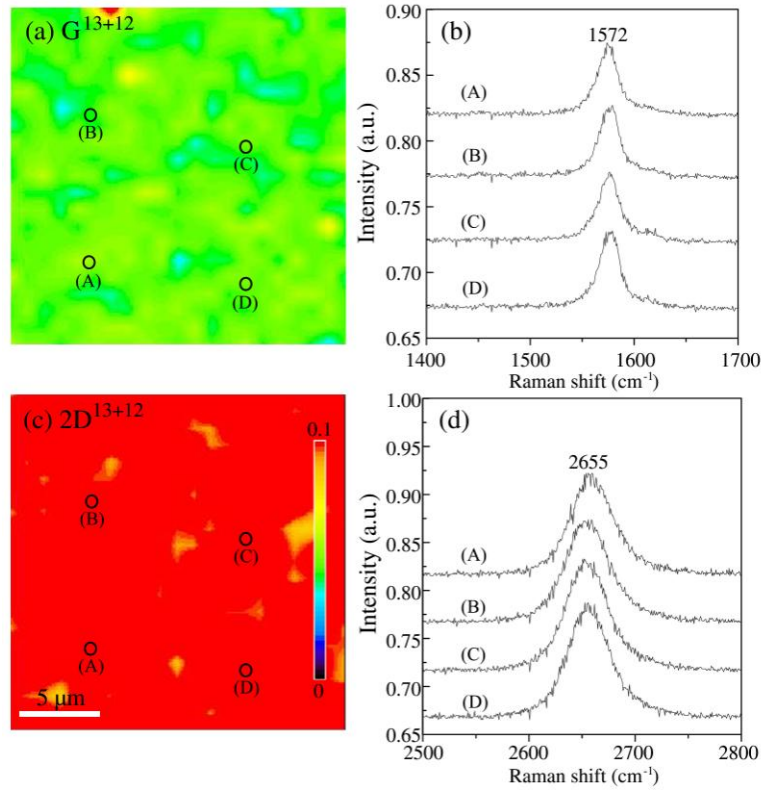


Fig. 6 Raman measurement of transferred graphene with $^{13}\text{CH}_4$ (0-3 min) and $^{12}\text{CH}_4$ (3-10 min) grown from 1000 °C CVD. Raman mapping images of G bands at 1570 cm^{-1} (a) and 2D bands at 2655 cm^{-1} (c). (b) and (d) are Raman spectra of G and 2D bands at 4 random points marked with (A), (B), (C), and (D) in the same region as (a) and (b), respectively.

Finally, we discuss the origin of different orientations of graphene films observed for 900 and 1000 °C CVD. From the previous isotope labeling experiments, carbon atoms on the Cu surface is suggested to have higher energies, stimulating thermal diffusion on the Cu surface as well as exchange reaction of carbon atoms between the Cu surface and vapor-supplied CH_4 gas at 1000 °C. Therefore, we propose that the as-grown graphene can have energetically the most stable orientation, which is commensurate structure with the underneath Cu(111) lattice. On the other hand, at 900 °C, the sub-stable 30°-oriented graphene domains also

grow due to insufficient thermal energy. Another possible reason for the observed different orientations is the different Cu surface morphology at 900 and 1000 °C. At 900 °C, there are significant amount of grain boundaries in the Cu film in the initial 3 minutes, as demonstrated in Fig. S-5, and the graphene nucleated from the boundaries may have rotated domains.

4. Conclusions

We demonstrate that orientation-controlled, large-area, and high-quality single-layer graphene can be grown on heteroepitaxial Cu(111) film deposited on c-plane sapphire by atmospheric pressure CVD. Compared to previous CVD results using heteroepitaxial Co, Ni, Ru films, the graphene grown on the present Cu(111) film shows much weaker D band, indicating the growth of high quality graphene and ease of the chemical etching without introducing clear damage to graphene. In addition, we find the temperature-dependent domain orientation of single-layer graphene. At relatively low growth temperature (900 °C), two orientations are observed, but higher temperature (1000 °C) gives rise to only one orientation which is consistent with the underlying Cu(111) lattice. Carbon isotope labeled CVD indicates the facile and dynamic exchange of surface carbon atoms on the Cu(111) which is quite different from the vacuum CVD system. The observed temperature-dependent orientation of graphene films is explained by different thermal energies and Cu surface structures. Our findings gives new insight into the growth mechanism of single-layer graphene on the Cu catalyst, and our approach will be further developed to grow extremely high-quality graphene for future carbon electronics applications.

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